## Onsemi

### **MOSFET** – Power, Single, **N-Channel**

60 V, 21 mΩ, 25 A

## NTMFS5C682NL

#### Features

- Small Footprint (5x6 mm) for Compact Design
- Low R<sub>DS(on)</sub> to Minimize Conduction Losses
- Low Q<sub>G</sub> and Capacitance to Minimize Driver Losses
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

	(.) =0					
Parameter			Symbol	Value	Unit	
Drain-to-Source Voltage			V <sub>DSS</sub>	60	V	
Gate-to-Source Voltage			V <sub>GS</sub>	±20	V	
Continuous Drain		T <sub>C</sub> = 25°C	I <sub>D</sub>	25	Α	
Current R <sub>θJC</sub> (Notes 1, 3)	Steady	T <sub>C</sub> = 100°C		18		
Power Dissipation	State	T <sub>C</sub> = 25°C	PD	28	W	
$R_{\theta JC}$ (Note 1)		T <sub>C</sub> = 100°C		14	1	
Continuous Drain		T <sub>A</sub> = 25°C	۱ <sub>D</sub>	8.8	Α	
Current R <sub>θJA</sub> (Notes 1, 2, 3)	Steady State	$T_A = 100^{\circ}C$		6.2		
Power Dissipation		T <sub>A</sub> = 25°C	PD	3.5	W	
$R_{\theta JA}$ (Notes 1 & 2)		T <sub>A</sub> = 100°C		1.7	1	
Pulsed Drain Current	T <sub>A</sub> = 25	°C, t <sub>p</sub> = 10 μs	I <sub>DM</sub>	130	А	
Operating Junction and Storage Temperature			T <sub>J</sub> , T <sub>stg</sub>	–55 to + 175	°C	
Source Current (Body Diode)			IS	31	А	
Single Pulse Drain-to-Source Avalanche Energy (I <sub>L(pk)</sub> = 1.1 A)			E <sub>AS</sub>	43	mJ	
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C	

#### MAXIMUM RATINGS (T = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### THERMAL RESISTANCE MAXIMUM RATINGS

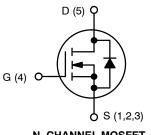
Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	5.3	°C/W
Junction-to-Ambient - Steady State (Note 2)	Bou	43	

The entire application environment impacts the thermal resistance values shown, 1. they are not constants and are only valid for the particular conditions noted.

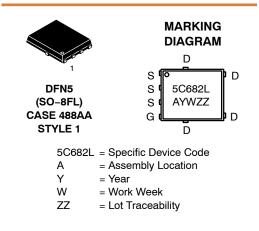
2. Surface-mounted on FR4 board using a 650 mm<sup>2</sup>, 2 oz. Cu pad.

3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX
60 V	21 mΩ @ 10 V	25 A
00 V	$31.5\mathrm{m}\Omega$ @ $4.5\mathrm{V}$	237







#### **ORDERING INFORMATION**

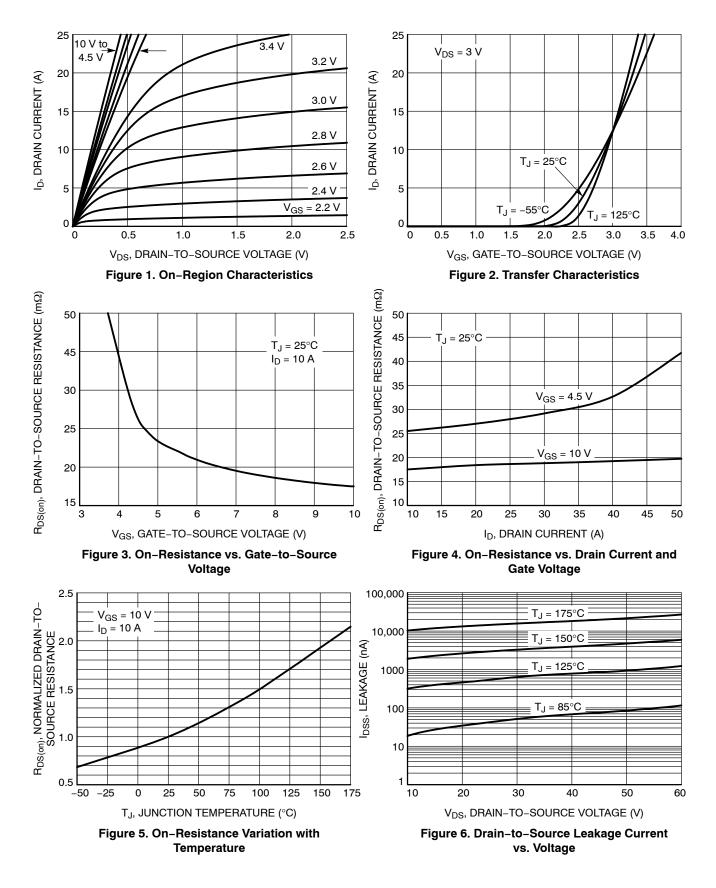
See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

#### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = $25^{\circ}C$ unless otherwise specified)

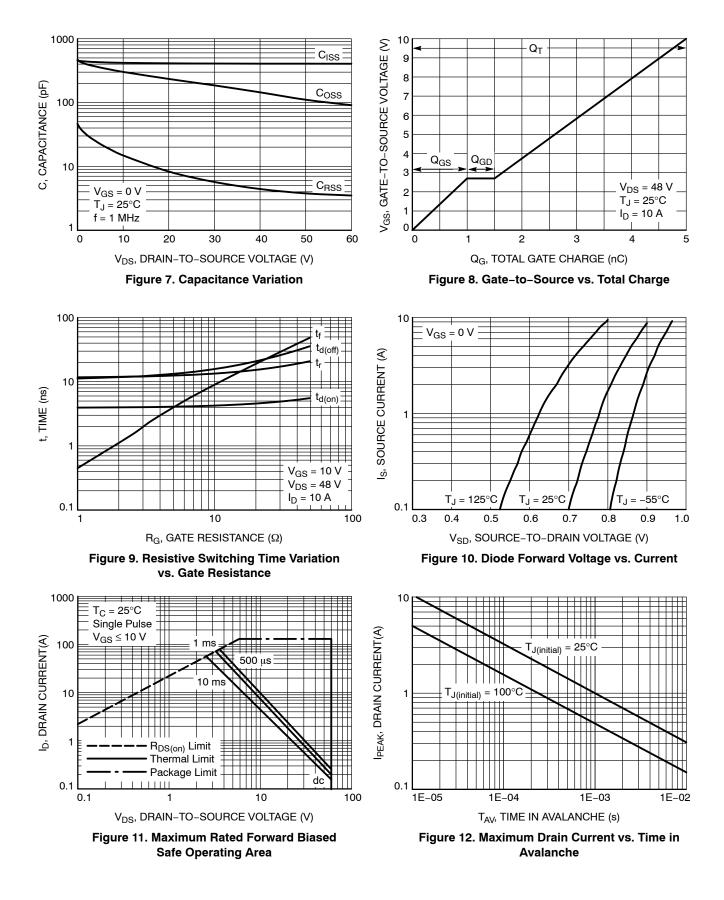
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS					•		
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS}$ = 0 V, I <sub>D</sub> = 250 µA		60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> / T <sub>J</sub>				28		mV/°C
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{GS} = 0 V$ , $T_J = 25 °C$				10	μΑ
		V <sub>DS</sub> = 60 V	T <sub>J</sub> = 125°C			250	
Gate-to-Source Leakage Current	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS}$	s = 20 V			100	nA
ON CHARACTERISTICS (Note 4)					-	-	-
Gate Threshold Voltage	V <sub>GS(TH)</sub>	$V_{GS} = V_{DS}$ , $I_D = 16 \mu A$		1.2		2.0	V
Threshold Temperature Coefficient	V <sub>GS(TH)</sub> /T <sub>J</sub>				-4.5		mV/°C
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 10 A		18	21	0
		V <sub>GS</sub> = 4.5 V	I <sub>D</sub> = 10 A		26	31.5	mΩ
Forward Transconductance	9 <sub>FS</sub>	V <sub>DS</sub> =15 V, I <sub>D</sub>	= 10 A		17		S
CHARGES AND CAPACITANCES					-	-	-
Input Capacitance	C <sub>ISS</sub>	V <sub>GS</sub> = 0 V, f = 1 MHz, V <sub>DS</sub> = 25 V			410		pF
Output Capacitance	C <sub>OSS</sub>				210		
Reverse Transfer Capacitance	C <sub>RSS</sub>				7.0		
Total Gate Charge	Q <sub>G(TOT)</sub>	V <sub>GS</sub> = 4.5 V, V <sub>DS</sub> = 48 V; I <sub>D</sub> = 10 A			2.5		nC
Total Gate Charge	Q <sub>G(TOT)</sub>	$V_{GS}$ = 10 V, $V_{DS}$ = 48 V; $I_{D}$ = 10 A			5.0		nC
Threshold Gate Charge	Q <sub>G(TH)</sub>	V <sub>GS</sub> = 10 V, V <sub>DS</sub> = 48 V; I <sub>D</sub> = 10 A			0.6		nC
Gate-to-Source Charge	Q <sub>GS</sub>				1.0		
Gate-to-Drain Charge	Q <sub>GD</sub>				0.5		
Plateau Voltage	V <sub>GP</sub>				2.7		V
SWITCHING CHARACTERISTICS (Note 5	)						
Turn-On Delay Time	t <sub>d(ON)</sub>	$V_{GS}$ = 10 V, $V_{DS}$ = 48 V, I <sub>D</sub> = 10 A, R <sub>G</sub> = 2.5 Ω			4.0		
Rise Time	tr				12		ns
Turn-Off Delay Time	t <sub>d(OFF)</sub>				12		
Fall Time	t <sub>f</sub>				1.5		
DRAIN-SOURCE DIODE CHARACTERIS	TICS						
Forward Diode Voltage	V <sub>SD</sub>	$V_{GS} = 0 V$ , $T_J = 25^{\circ}C$			0.9	1.2	
			T <sub>J</sub> = 125°C		0.8		V
Reverse Recovery Time	t <sub>RR</sub>	V <sub>GS</sub> = 0 V, dI <sub>S</sub> /dt = 100 A/µs, I <sub>S</sub> = 10 A			18		
Charge Time	t <sub>a</sub>				9.0		ns
Discharge Time	t <sub>b</sub>				9.0		
Reverse Recovery Charge	Q <sub>RR</sub>				7.0		nC

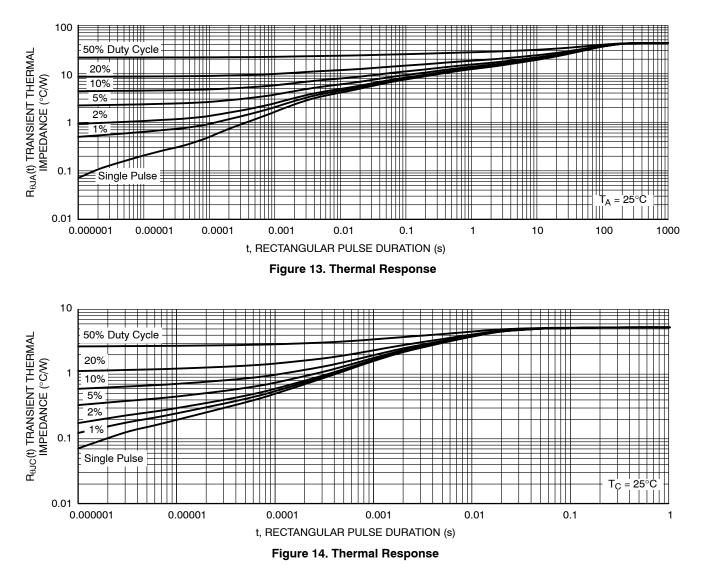
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width  $\leq 300 \ \mu$ s, duty cycle  $\leq 2\%$ . 5. Switching characteristics are independent of operating junction temperatures.

#### **TYPICAL CHARACTERISTICS**



#### **TYPICAL CHARACTERISTICS**





#### **DEVICE ORDERING INFORMATION**

Device	Marking	Package	Shipping <sup>†</sup>
NTMFS5C682NLT1G	5C682L	DFN5 (Pb–Free)	1500 / Tape & Reel
NTMFS5C682NLT3G	5C682L	DFN5 (Pb–Free)	5000 / Tape & Reel

<sup>+</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# onsemi



onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent\_Marking.pdf</u>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or indental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification. Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs,

#### ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com

ONLINE SUPPORT: <u>www.onsemi.com/support</u> For additional information, please contact your local Sales Representative at <u>www.onsemi.com/support/sales</u>